

POWER/Q2TM SIGNAL COMBO QMS-PC, QFS-PC

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?QMS-PC or www.samtec.com?QFS-PC

Insulator Material: Liquid Crystal Polymer

Contact, Terminal &
Ground Plane Material:
Phosphor Bronze

Plating: Au over 50μ" (1,27μm) Ni (Tin on Ground Plane Tail)

Insertion Depth (Power Pins): (2,29mm) .090" to (4,06mm) .160"

Wiping Distance
(Power Pins):
(0,38mm) .015"
Current Rating:
Signal Contact: 1.8A @ 80°C
Power Contact: See chart
Ground Plane: 8.9A @ 80°C
Voltage Rating: 300 VAC
Operating Temp:
-55°C to +125°C

RoHS Compliant:

CURRENT RATING	
AMBIENT TEMP	QMS-PC/QFS-PC
20°C	5.0A
40°C	4.5A
60°C	4.0A
95°C	2.7A
8 POWER PINS POWERED	

Processing:

Max Processing Temp: 230°C for 60 seconds, or 260°C for 20 seconds 3x Lead-Free Solderable:

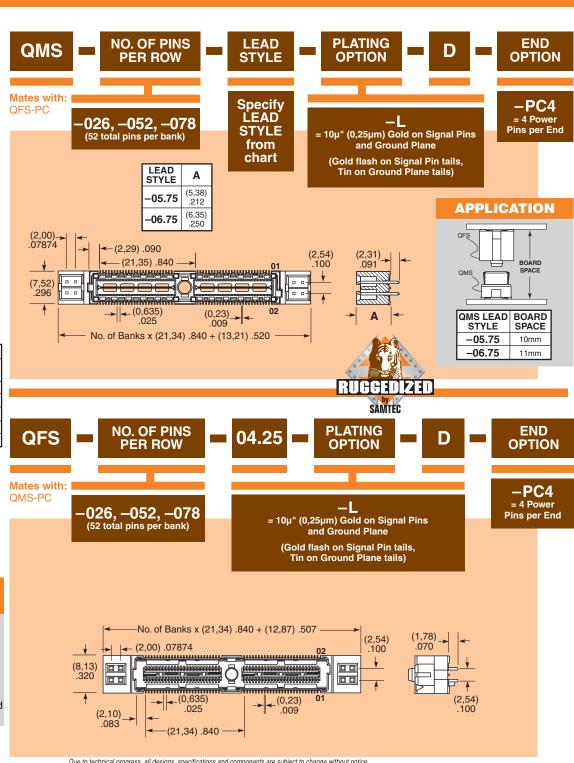
SMT Lead Coplanarity: (0,10mm) .004" max (026-078) Board Stacking:

For applications requiring more than two connectors per board, contact ipg@samtec.com

APPLICATION SPECIFIC OPTION

- Shielded (See QMSS/QFSS Series)
- Differential Pairs
- 8 Power Pins/End for (1,60mm) .062" thick board
- 4 or 8 Power Pins/End for (2,36mm) .093" thick board Call Samtec.

Note: Some lengths, styles and options are non-standard, non-returnable.



Due to technical progress, all designs, specifications and components are subject to change without notice.